

# STARPOWER

SEMICONDUCTOR™

# IGBT

## GD75FFT60C5S

## Preliminary

**Molding Type Module****600V/75A 6 in one-package**

### General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.



### Features

- Low  $V_{CE(sat)}$  trench IGBT technology
- Low switching losses
- 5 $\mu$ s short circuit capability
- $V_{CE(sat)}$  with positive temperature coefficient
- Maximum junction temperature 175°C
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology

### Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

**Absolute Maximum Ratings**  $T_C=25^{\circ}\text{C}$  unless otherwise noted

Symbol	Description	GD75FFT60C5S	Units
$V_{CES}$	Collector-Emitter Voltage	600	V
$V_{GES}$	Gate-Emitter Voltage	$\pm 20$	V
$I_C$	Collector Current @ $T_C=25^{\circ}\text{C}$ @ $T_C=80^{\circ}\text{C}$	130 75	A
$I_{CM(1)}$	Pulsed Collector Current @ $T_C=80^{\circ}\text{C}$	150	A
$I_F$	Diode Continuous Forward Current	75	A
$I_{FM}$	Diode Maximum Forward Current	150	A
$P_D$	Maximum power Dissipation @ $T_j=150^{\circ}\text{C}$	405	W
$T_{SC}$	Short Circuit Withstand Time @ $T_j=150^{\circ}\text{C}$	5	$\mu\text{s}$
$T_j$	Maximum Junction Temperature	175	$^{\circ}\text{C}$
$T_{STG}$	Storage Temperature Range	-40 to +125	$^{\circ}\text{C}$
$V_{ISO}$	Isolation Voltage RMS, $f=50\text{Hz}$ , $t=1\text{min}$	2500	V
Mounting Torque	Mounting Screw: M5	3.0 to 6.0	N.m

**Notes:**

(1) Repetitive rating: Pulse width limited by max. junction temperature

**Electrical Characteristics of IGBT**  $T_C=25^{\circ}\text{C}$  unless otherwise noted**Off Characteristics**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{(BR)CES}$	Collector-Emitter Breakdown Voltage	$T_j=25^{\circ}\text{C}$	600			V
$I_{CES}$	Collector Cut-Off Current	$V_{CE}=V_{CES}$ , $V_{GE}=0\text{V}$ , $T_j=25^{\circ}\text{C}$			5.0	mA
$I_{GES}$	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}$ , $V_{CE}=0\text{V}$ , $T_j=25^{\circ}\text{C}$			400	nA

**On Characteristics**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=2.1\text{mA}$ , $V_{CE}=V_{GE}$ , $T_j=25^{\circ}\text{C}$	4.0		6.5	V
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=75\text{A}$ , $V_{GE}=15\text{V}$ , $T_j=25^{\circ}\text{C}$		1.70	2.10	V
		$I_C=75\text{A}$ , $V_{GE}=15\text{V}$ , $T_j=150^{\circ}\text{C}$		2.10		

## Switching Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=400V, I_C=75A,$ $R_G=10\Omega, V_{GE}=\pm 15V,$ $T_j=25^\circ C$		50		ns
$t_r$	Rise Time			70		ns
$t_{d(off)}$	Turn-Off Delay Time			200		ns
$t_f$	Fall Time			60		ns
$E_{on}$	Turn-On Switching Loss			2.47		mJ
$E_{off}$	Turn-Off Switching Loss			2.16		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=400V, I_C=75A,$ $R_G=10\Omega, V_{GE}=\pm 15V,$ $T_j=175^\circ C$		50		ns
$t_r$	Rise Time			70		ns
$t_{d(off)}$	Turn-Off Delay Time			240		ns
$t_f$	Fall Time			70		ns
$E_{on}$	Turn-On Switching Loss			3.87		mJ
$E_{off}$	Turn-Off Switching Loss			2.82		mJ
$C_{ies}$	Input Capacitance	$V_{CE}=30V, f=1MHz,$ $V_{GE}=0V$		4.44		nF
$C_{oes}$	Output Capacitance			0.25		nF
$C_{res}$	Reverse Transfer Capacitance			0.13		nF
$I_{SC}$	SC Data	$T_P \leq 5\mu s, V_{GE}=15V,$ $T_j=150^\circ C, V_{CC}=360V,$ $V_{CEM} \leq 600V$		TBD		A
$L_{CE}$	Stray Inductance			19		nH
$R_{CC'+EE'}$	Module Lead Resistance, Terminal To Chip			2.5		m $\Omega$

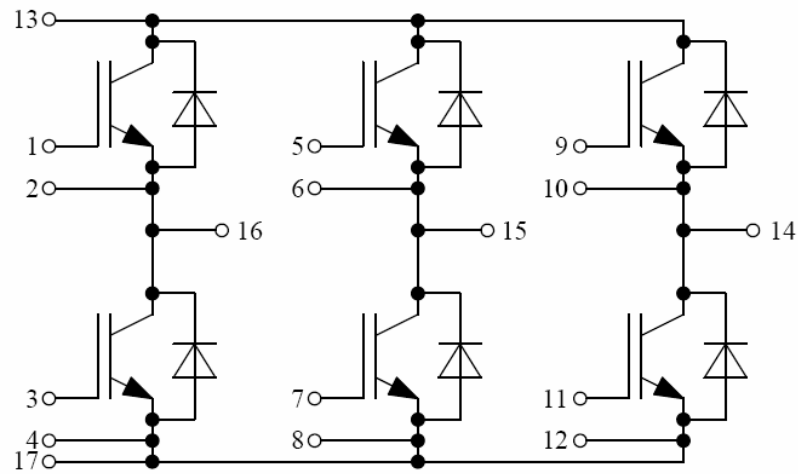
Electrical Characteristics of DIODE  $T_C=25^\circ C$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_F$	Diode Forward Voltage	$I_F=75A$	$T_j=25^\circ C$	1.50	1.90	V
			$T_j=125^\circ C$	1.55		
$Q_r$	Recovered charge	$I_F=75A,$	$T_j=25^\circ C$	3.2		$\mu C$
			$T_j=125^\circ C$	4.2		
$I_{RM}$	Peak Reverse Recovery Current	$V_R=300V,$ $di/dt=-1200A/\mu s,$	$T_j=25^\circ C$	49		A
			$T_j=125^\circ C$	51		
$E_{rec}$	Reverse Recovery Energy	$V_{GE}=-15V$	$T_j=25^\circ C$	0.76		mJ
			$T_j=125^\circ C$	0.96		

**Thermal Characteristics**

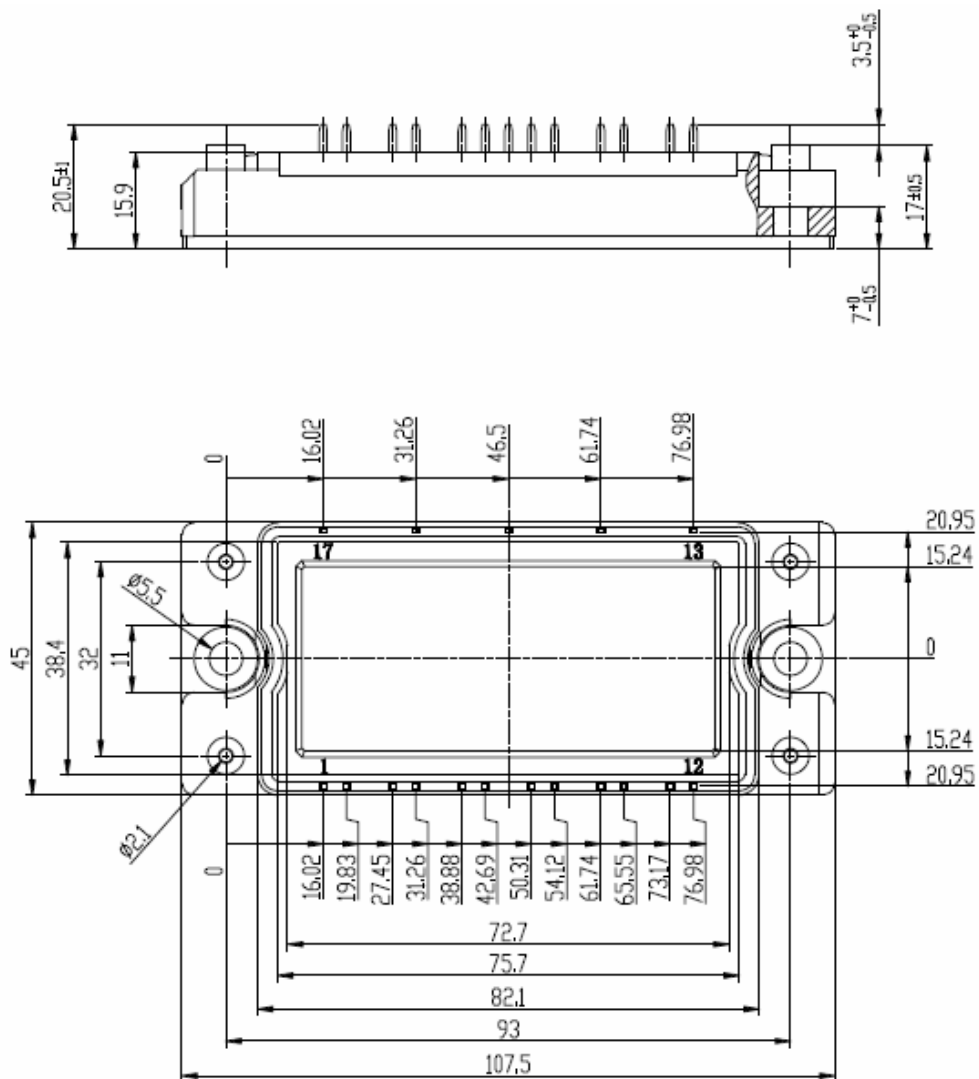
Symbol	Parameter	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case (per IGBT)		0.37	K/W
$R_{\theta JC}$	Junction-to-Case (per DIODE)		0.52	K/W
$R_{\theta CS}$	Case-to-Sink (Conductive grease applied)	0.02		K/W
Weight	Weight of Module	200		g

**Equivalent Circuit Schematic**



**Package Dimension**

Dimensions in Millimeters



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